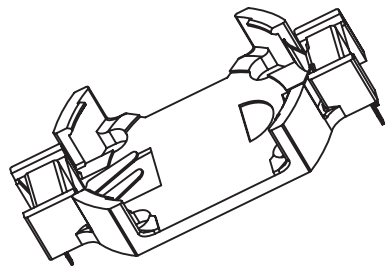


PCB Holes Diagram



NOTE:

- 1.MATERIAL:
 a.HOUSING:THERMOPLASTIC GLASS FIBRE UL94V-0
 b.CONTACT:PHOSPHOR BRONZE
 (SURFACE PLATING: Nickel-tin100u")
 SEE ORDERING INFORMATION

- 2.ELECTRIC:
 a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
 b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
 c.DIELECTNIC VOLTAGE: 750V AC ONE SEC LEVEL
 d.OPERATING TEMPERATURE: -55°C~ +85°C

3	TERMINAL-2	PHOSPHOR BRONZE	Nickel-tin-Plated
2	TERMINAL-1	PHOSPHOR BRONZE	Nickel-tin-Plated
1	HOUSING	LCP	WHITE
NO.	PART NAME	MATERIAL	COLOR/FINISHED



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 电池座 DIP
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW-BS-6-2-CR2032
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO. / DRAW NO. HYC-2201121712
			SHEET NO. 1 OF 1